

# 2N5551HR

### Hi-Rel NPN bipolar transistor 160 V, 0.5 A

#### Datasheet — production data

#### Features

BV <sub>CEO</sub>	160 V	
I <sub>C</sub> (max)	0.5 A	
H <sub>FE</sub> at 5 V - 10 mA	> 80	
Operating temperature range	-65 °C to +200 °C	

- Linear gain characteristics
- ESCC qualified
- European preferred part list EPPL
- 100 krad low dose rate
- Hermetic packages

#### Description

The 2N5551HR is a silicon planar epitaxial NPN transistor in TO-18, TO-39 and LCC-3 packages. It is specifically designed for aerospace Hi-Rel applications and ESCC qualified according to the 5201-019 specification. In case of conflict between this datasheet and ESCC detailed specification, the latter prevails.

TO-18	LCC-3				
TO-39					
10-03					

#### Figure 1. Internal schematic diagram

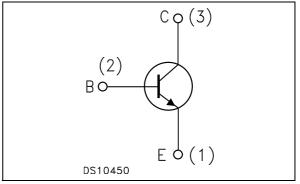


Table 1. Device Summary							
Order codes	ESCC Part number	Qual. Level	Rad. level	Packages	Lead Finish	Mass (g)	EPPL
2N5551UB1	-	Eng. Model		LCC-3UB	Gold	0.06	-
2N5551UB	5201/019/08 or 09	ESCC Flight		LCC-3UB	Gold / Solder Dip <sup>(1)</sup>	0.06	-
SOC5551	-	Eng. Model		LCC-3	Gold	0.06	-
SOC5551HRB	5201/019/04 or 05	ESCC Flight		LCC-3	Gold / Solder Dip <sup>(1)</sup>	0.06	Y
SOC5551SW	5201/019/05	ESCC Flight	100 krad	LCC-3	Solder Dip	0.06	Y
2N5551/T1	-	Eng. Model		TO-18	Gold	0.40	-
2N5551HR	5201/019/01 or 02	ESCC Flight		TO-18	Gold / Solder Dip <sup>(1)</sup>	0.40	-
2N5551SHR	5201/019/06 or 07	ESCC Flight		TO-39	Gold / Solder Dip (1)	1.20	-

Table 1. Device summary

1. Depending ESCC part number mentioned on the purchase order.

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This is information on a product in full production.

## 1 Electrical ratings

Table 2. Absolute maximum ratings	Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit	
$V_{CBO}$	Collector-base voltage (I <sub>E</sub> = 0)	180	V	
V <sub>CEO</sub>	Collector-emitter voltage $(I_B = 0)$	160	V	
$V_{\text{EBO}}$	Emitter-base voltage (I <sub>C</sub> = 0)	6	V	
Ι <sub>C</sub>	Collector current for 2N5551HR for SOC5551HRB	0.6 0.5	A A	
P <sub>TOT</sub>	Total dissipation at $T_{amb} \leq 25 \degree C$ for 2N5551HR for SOC5551HRB for SOC5551HRB for SOC5551HRB <sup>(1)</sup> Total dissipation at $T_c \leq 25 \degree C$ for 2N5551HR	0.36 0.36 0.58 1.2	w w w	
T <sub>STG</sub>	Storage temperature	-65 to 200	°C	
Τ <sub>J</sub>	Max. operating junction temperature	200	°C	

1. When mounted on a  $8 \times 10 \times 0.6$  mm ceramic substrate.

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case max	146	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient max	486	°C/W

#### Table 4. Thermal data for SMD package

Symbol	Parameter	Value	Unit
D	Thermal resistance junction-ambient max	486	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient <sup>(1)</sup> max	302	°C/W

1. When mounted on a  $8 \times 10 \times 0.6$  mm ceramic substrate.



### 2 Electrical characteristics

 $T_{case}$  = 25 °C unless otherwise specified.

Table 5.	e 5. Electrical characteristics						
Symbol	Parameter	Test co	Test conditions		Тур.	Max.	Unit
I <sub>CBO</sub>	Collector-base cut-off current (I <sub>E</sub> = 0)	V <sub>CB</sub> = 120 V V <sub>CB</sub> = 120 V	T <sub>C</sub> = 150 °C		-	50 50	nΑ μA
I <sub>EBO</sub>	Emitter-base cut-off current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 4 V			-	50	nA
V <sub>(BR)CBO</sub>	Collector-base breakdown voltage (I <sub>E</sub> = 0)	l <sub>C</sub> = 100 μΑ		180	-		V
V <sub>(BR)CEO</sub> <sup>(1)</sup>	Collector-emitter breakdown voltage $(I_B = 0)$	I <sub>C</sub> = 1 mA		160	-		V
V <sub>(BR)EBO</sub>	Emitter-base breakdown voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 μA		6	-		v
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	I <sub>C</sub> = 10 mA I <sub>C</sub> = 50 mA	l <sub>B</sub> = 1 mA l <sub>B</sub> = 5 mA		-	0.15 0.2	<ul><li></li></ul>
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	I <sub>C</sub> = 10 mA I <sub>C</sub> = 50 mA	l <sub>B</sub> = 1 mA l <sub>B</sub> = 5 mA		-	1 1	<ul><li></li></ul>
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$I_{C} = 1 \text{ mA}$ $I_{C} = 10 \text{ mA}$ $I_{C} = 50 \text{ mA}$ $I_{C} = 10 \text{ mA}$ $T_{amb} = -55 \text{ °C}$	$V_{CE} = 5 V$ $V_{CE} = 5 V$ $V_{CE} = 5 V$ $V_{CE} = 5 V$	80 80 30 20	-	250	
h <sub>fe</sub>	Small signal current gain	V <sub>CE</sub> = 10 V f = 1 kHz	I <sub>C</sub> = 1 mA	50	-	200	
h <sub>fe</sub>	Small signal current gain	V <sub>CE</sub> = 10 V f > 100 MHz	l <sub>C</sub> = 10 mA	1	-		
C <sub>obo</sub>	Output capacitance (I <sub>E</sub> = 0)	V <sub>CB</sub> = 10 V	f = 1 MHz		-	6	pF
C <sub>ebo</sub>	Emitter-base capacitance (I <sub>C</sub> = 0)	V <sub>EB</sub> = 5 V	f = 1 MHz		-	20	pF

 Table 5.
 Electrical characteristics

1. Pulsed duration = 300  $\mu$ s, duty cycle  $\leq$ 1.5%



### 2.1 Electrical characteristics (curves)

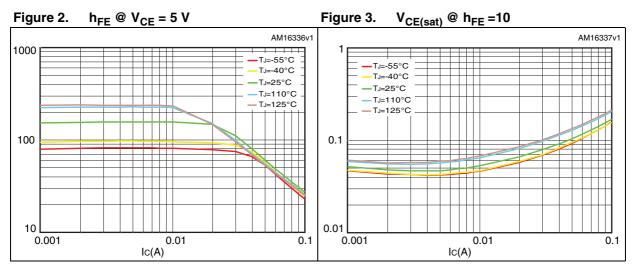
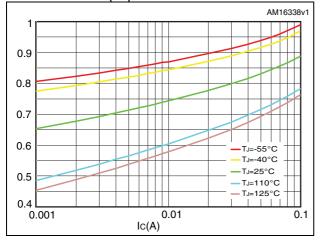


Figure 4. V<sub>BE(sat)</sub> @ h<sub>FE</sub> =10





## 3 Package mechanical data

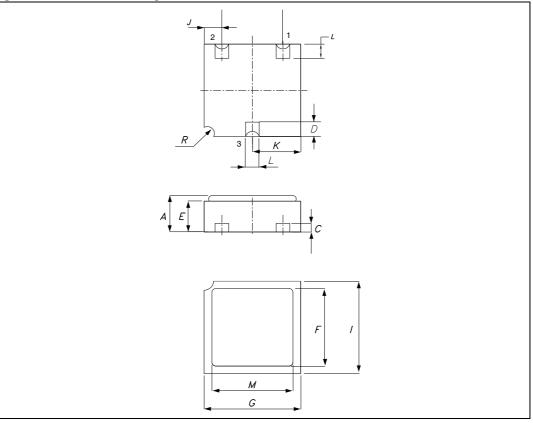
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Dim.		mm.			
	Min.	Тур.	Max.		
A	1.16		1.42		
С	0.45	0.50	0.56		
D	0.60	0.76	0.91		
E	0.91	1.01	1.12		
F	1.95	2.03	2.11		
G	2.92	3.05	3.17		
I	2.41	2.54	2.66		
J	0.42	0.57	0.72		
К	1.37	1.52	1.67		
L	0.40	0.50	0.60		
М	2.46	2.54	2.62		
N	1.80	1.90	2.00		
R		0.30			

Table 6. LCC-3 mechanical data



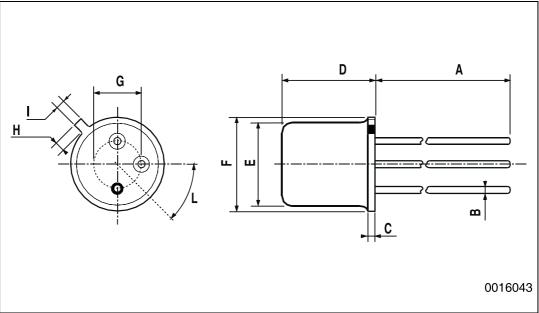




Dim.	mm.			
Din.	Min.	Тур.	Max.	
A		12.7		
В			0.49	
D			5.3	
E			4.9	
F			5.8	
G	2.54			
Н			1.2	
I			1.16	
L	45°			

Table 7. TO-18 mechanical data



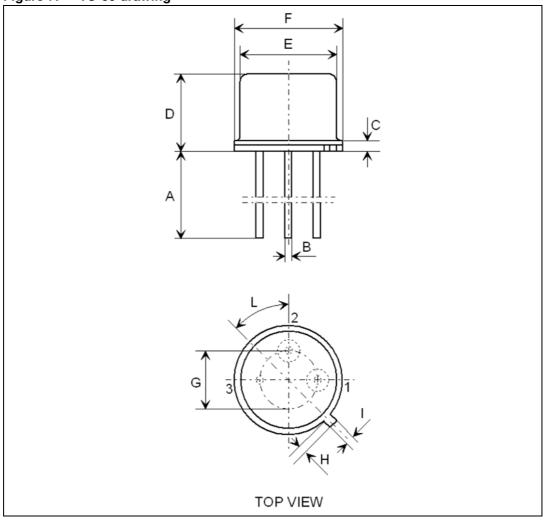




mm					
Dim. –	Min.	Тур.	Max.		
А		12.70	14.20		
В		0.40	0.49		
С		0.58	0.74		
D		6.00	6.40		
E		8.15	8.25		
F	-	9.10	9.20		
G		4.93	5.23		
Н		0.85	0.95		
I		0.75	0.85		
L		42°	48°		

#### Table 8. TO-39 mechanical data







### 4 Order codes

Order codes	ESCC Part number	Radiation level	Packages	Lead Finish	Marking	EPPL	Packing
2N5551UB1	-		LCC-3UB	Gold	2N5401UB1	-	Waffle Pack
2N5551UB	5201/019/08 or 09		LCC-3UB	Gold / Solder Dip <sup>(1)</sup>	520101908 or 09	-	Waffle Pack
SOC5551	-		LCC-3	Gold	SOC5551	-	Waffle Pack
SOC5551HRB	5201/019/04 or 05		LCC-3	Gold / Solder Dip <sup>(1)</sup>	520101904 or 05	Y	Waffle Pack
SOC5551SW	5201/019/05	100 krad	LCC-3	Solder Dip	520101904 or 05	Y	Waffle Pack
2N5551/T1	-		TO-18	Gold	2N5551/T1	-	Strip Pack
2N5551HR	5201/019/01 or 02		TO-18	Gold / Solder Dip <sup>(1)</sup>	520101901 or 02	-	Strip Pack
2N5551SHR	5201/019/06 or 07		TO-39	Gold / Solder Dip <sup>(1)</sup>	520101906 or 07	-	Strip Pack

1. Depending ESCC part number mentioned on the purchase order.

Contact ST sales office for information about the specific conditions for:

- Products in die form
- Tape and reel packing



## 5 Revision history

#### Table 10. Document revision history

Date	Revision	Changes	
04-Jan-2010	1	Initial release	
17-May-2010	2	Modified: Table 1 on page 1 and Table 9 on page 9	
12-Jul-2010	3	Modified: Table 1 on page 1 and Table 9 on page 9	
13-Nov-2012	4	Added: Section 2.1: Electrical characteristics (curves)	



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